

8K X 8 Electrically Erasable PROM

FEATURES

- Fast Read Access Times — 250ns, 300ns, 350ns, 450ns
- 5 Volt-only Operation — Including Write
- Industrial Temperature Range Available (XLE2865A)
- Fast Nonvolatile Write Cycle
 Internally Latched Data and Address
 - 200ns Byte-load Cycle
 - 10ms Nonvolatile Write Cycle
- On-chip Inadvertent Write Protection
- Unlimited Read Cycle Endurance
- 10,000 Rewrites per Byte
- 10 Year Secure Data Retention
- DATA Polling To Minimize Write Cycle Times
- READY/BUSY Pin Status Indicator
- Automatic Page Write
 1 to 32 bytes in 10ms (max.)
- TTL Compatible Inputs and Outputs

OVERVIEW

The XL2865A is a full-featured, 8K x 8 bit E²PROM (Electrically Erasable Programmable Read Only Memory). Operationally, it is compatible with industry standard 16K bit E²PROM devices. Read access times are as low as 250ns; standby current, less than 50mA. The device is fully functional with a single 5V power supply, and the XL2865A is manufactured with EXEL's 2.0µ NMOS E²PROM process.

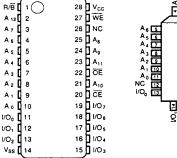
The device is exceptionally system friendly, incorporating a device status indicator and a fully automatic 32-byte page write feature. DATA polling and a READY/BUSY pin are provided to maximize device versatility and allow the host system to exploit the actual nonvolatile write cycle time. This is a software technique which is used to observe nonvolatile write cycle completion without requiring external hardware.

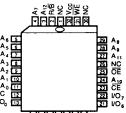
PIN CONFIGURATION

	Pin PDIP P" Package	28 Pin (Type "C"	
R/B 【1	28 V _{cc}	R/B (1	28 V _{cc}
A 12 2	27 🕽 WE	A 120 2	27 🕽 WE
A 7 🕻 3	26 🕽 NC	A 7 🚺 3	26 🕽 NC
A 6 🕻 4	25 🕽 🗛	A 6 🛛 4	25 🕽 A
A s 🚺 5	24 🕽 A,	A 5 🚺 5	24 🕽 A,
A 4 🛛 6	23 🕽 A ₁₁	A 4 🛛 6	23 🕽 A,,
A 3 🚺 7	22 🕽 ŌĒ	A 3 🚺 7	22 🕽 ÖE
A 2 🚺 8	21 A ₁₀	A 2 🚺 8	21 🛭 A ₁₀
A 1 🛛 9	20 🕽 CE	A 1 🗓 9	20 🛭 CE
A o 🛛 10	19 🛮 1/07	A o 📮 10	19 🛭 1/07
1/00 🚺 11	18 🛮 1/06	1/0, 🛛 11	18 🛭 1/06
1/0, 🕻 12	17 🕽 I/Os	1/0, 🛚 12	17 🛭 1/0 s
1/02 🛘 13	16 🛭 1/0₄	1/O ₂ 🕻 13	16 🛭 1/04
V _{SS} 🚺 14	15 🕽 1∕O₃	V _{SS} 🛚 14	15 🛭 1/03









32 Pin PLCC

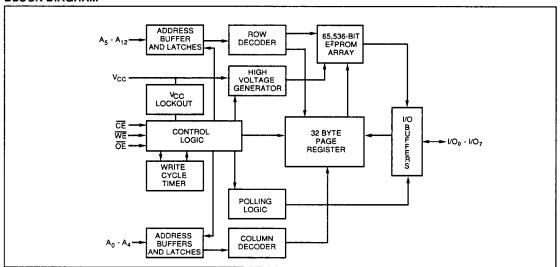
Type "D" Package

PIN NAMES

	A ₀ -A ₁₀	Address Inputs
	1/00-1/07	Data Inputs/Outputs
	CE	Chip Enable
	ŌĒ	Output Enable
	WE	Write Enable
	R/B	READY/BUSY Indicator
	Vcc	Supply Voltage
	Vss	Power and Signal Ground
i	NC	No Connect



BLOCK DIAGRAM



The automatic page write feature allows the system to program up to 32 bytes during a single nonvolatile write cycle, providing an effective write speed of at most 312ms/byte. The entire 8K byte memory may be programmed in a maximum of 2.6 seconds when the page write mode is employed.

The XL2865A features $\overline{\text{OE}}$ write inhibit logic and noise protected $\overline{\text{WE}}$ to inhibit inadvertent writes.

The XL2865A is compatible with industrial standard 8K \times 8 E²PROMS — its pinouts and operating modes conform to established standards. This compatibility extends to higher and lower density EXEL E²PROMS as well.

APPLICATIONS

The XL2865A provides secure and reliable data storage thoughout your system's lifetime both during periods of power on and power off. It may be written to through standard microprocessor protocols as if it were a Static RAM, yet it retains its data in the absence of system power for at least 10 years after the data is written. This flexibility has resulted in a wide variety of digital system applications.

The nonvolatile storage in the XL2865A replaces dip switches as a means of storing configuration data. It delivers firmware for booting up systems, and for operating industrial and process controllers, traffic controllers, robotics and telemetry, measuring instruments and appliance controls. It retains phone numbers and messages in facsimile machines. The XL2865A is ideal in applications that are self-adapting such as video games and systems that require automatic re-calibration, as well as those that are subject to power failures.

ENDURANCE and DATA RETENTION

The XL2865A is designed for applications requiring up to 10,000 data writes per E²PROM byte ensuring a guaranteed endurance of 20 million data changes per device. It provides 10 years of secure data retention, with or without power applied after the data is written.

The latches in the automatic page write buffer include corresponding flag bits which are set when a given page location is written. In the event that a nonvolatile write cycle occurs with less than 32-bytes of data, only those bytes in the E²PROM array corresponding to the locations in the buffer which were actually written will be reprogrammed. This feature eliminates unnecessary cycling and ensures maximum endurance. This is in contrast to some competing E²PROM devices which reprogram the full page of nonvolatile locations independent of the number of page latches actually written to. This wastes cell cycles and may substantially reduce device endurance and, consequently, system reliability.



DEVICE OPERATION

Three control pins $(\overline{CE}, \overline{OE} \text{ and } \overline{WE})$ select all standard, user operating modes for the XL2865A. Chip erase (typically executed during test procedures) requires a higher supply voltage on one input pin. This conforms with existing E²PROM standards.

Read Mode

Data is read from the XL2865A by bringing both \overline{CE} and \overline{OE} LOW while keeping \overline{WE} HIGH. With the read mode selected, address lines can be changed at any time, in any order to read data at various locations in the E^2 PROM array. Read access time is measured from the time when the final controlling line (\overline{CE} or \overline{OE}) goes LOW, or the time when the address is established.

The device can be read an unlimited number of times, because the stored charge that defines the bit state is not affected by a read cycle. (See Figure 2.)

Output Disable Mode

If, while in the read mode, \overline{OE} is brought HIGH, the device remains in the read mode, but with the outputs disabled. (I/O pins are in a high impedance state.)

Write Mode

In the XL2865A, the write cycle is initiated by applying a logical "0" to both WE and CE while OE is logical "1." The address inputs are latched into the device on the falling edge of WE or CE (whichever is last) to specify the address that is to be written. Data on the I/O pins is then latched into the device by bringing either WE or CE HIGH. Both address and data are latched in a brief 150ns interval using a 5V supply and TTL write signals.

Once the data is latched, the XL2865A will automatically erase the selected byte and write the new data in less than 10ms. The host system is therefore freed to proceed with other operations while the XL2865A autonomously executes its internal write cycle. The I/O pins will be in a high impedance state while the write operation is in progress with the exception of I/O7 if a read command is asserted. (See monitoring device status in the next column of this page.) (See Figures 3 and 4.)

Standby Mode

Whenever \overline{CE} is brought HIGH, the device is set into its standby mode, placing the I/O pins in a high impedance state. Standby power dissipation is less than 50mA. While \overline{CE} remains HIGH, all other input pins are disabled, insulating the device from activity on the system busses.

Chip Erase — High Voltage Mode

The chip erase mode allows the user to erase the entire E²PROM array with a single command. The method requires the application of high voltage (VH) on the OE pin, with CE at a logical "0." Chip erase is initiated by a standard byte write command while holding data on the I/O inputs HIGH. A byte containing all "1's" is automatically written to all locations in the E²PROM array. (Refer to Mode Selection chart.)



MONITORING DEVICE STATUS

Because the internal nonvolatile write cycle is completely managed by the XL2865A, a status indicator has been incorporated to provide for the host system to monitor the READY/BUSY status of the device. This is accomplished through a system software routine which simply re-reads the XL2865A until it determines a simple logical condition.

DATA Polling

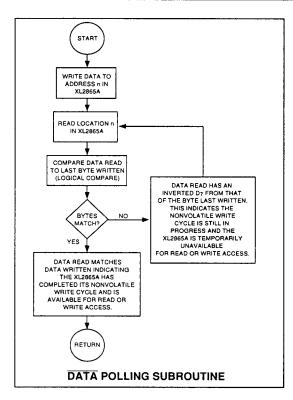
The XL2865A provides a feature named DATA polling which enables the host system to determine the status of the device through the use of the system busses. No additional hardware is required. Any attempt to read the part while the XL2865A is busy executing its nonvolatile write cycle will be interpreted as a DATA polling read. This is performed by exercising the control pins in the same sequence as for a normal read. DATA polling cycles have no effect on the byte-load timer, contents of the data buffer or nonvolatile write cycle timing.

MODE SELECTION

CE	ŌĒ	WE	Mode	I/O	Power
ViH	Х	Х	Standby	High Z	Standby
VIL	ViL	V _{1H}	Read	Dout	Active
٧ıL	ViH	7	Byte Write (WE Controlled)	Din	Active
[ViH	VıL	Byte Write (CE Controlled)	DiN	Active
ViL	Vн		Chip Erase*	DIN = VIH	Active
Х	VIL	X	Write Inhibit		_

^{*}Contact EXEL Microelectronics for details on the Chip Erase Mode.





DATA polling is a simple software technique used to determine the status of the XL2865A. It is executed as a normal read cycle where the target byte location is the same as that of the byte last written to the XL2865A. During the 10ms (max.) period that the device requires to complete its nonvolatile write cycle, the I/O buffers are set in a high impedance state with the exception of I/O7. I/O7 is set to output the **complement** of the value of the MSB of the last byte written to the XL2865A when a read command is asserted. (See Figure 5.)

The READY/BUSY test procedure is quite simple. The system simply reads the location last written to in the XL2865A and executes a compare operation between the data thus retrieved and the original data byte written. If the compare fails, the XL2865A is still busy with its nonvolatile write cycle. If the compare passes, the nonvolatile write cycle is complete and the device is available for read or write accesses.

This procedure is commonly used to determine the actual nonvolatile write cycle completion timing, eliminating the need to wait the 10ms (max.) period specified and enabling accelerated device loading operations.

READY/BUSY Pin (R/B)

The R/B pin (pin 1) is a dedicated status indicator which remains at a logic "1" during device operation unless the XL2865A is internally occupied with a nonvolatile write cycle or the supply voltage is below 4.0V. When a system write cycle is initiated, R/B is brought to a logic "0", returning to a logic "1" when the corresponding nonvolatile write cycle is completed. This pin may be conveniently polled for nonvolatile write cycle status or may be used to initiate an interrupt announcing to the controller that the cycle is complete and the device is, once again, available for normal access. This output is configured as an open-drain driver to be OR-tied and thus requires an appropriate pullup resistor for proper operation. The pull-up resistor value for the R/B output may be calculated as follows:

$$RP = \frac{5.1V}{I_{IL} + 2.1mA}$$

where I1L = the sum of the input currents of all the devices tied to R/\overline{B} .

Automatic Page Write

The XL2865A contains a 32-byte temporary (volatile) buffer which allows the user to simultaneously program from one to 32 bytes in a page during a single 10ms (max.) nonvolatile write cycle without any special setup or software procedures. This can effectively reduce the byte write time by a factor of 32. The device will begin its nonvolatile write cycle from 300 to 600µs (tPL) after the first system write operation following the completion of a previous nonvolatile write cycle (or power-up). At this point, the device commences a nonvolatile write cycle and copies data from each of the latches which were updated into the designated E²PROM locations (see Endurance and Data Retention section). Thus, all bytes to be programmed during an automatic page write cycle must be written into the page buffer within tPL minimum to guarantee that they are transferred into the E²PROM array. (See Figure 6).

The 32-byte page into which the data will be written is specified by the most significant bits of the address (A5-A12) presented during the first system write operation following the completion of a previous nonvolatile write cycle (or power-up). The byte within the specified page is identified by the five least significant bits of the address (A0-A4) presented during the first and subsequent system write cycles. Bytes may be written into the page in any order. If data is written more than once to the same byte in the temporary buffer during a single page load operation, then the most recently written data will be valid.

If a read operation is attempted during loading of the page buffer, the buffer load cycle is not affected. However, that read cycle will be interpreted as a DATA polling cycle.



WRITE PROTECT MECHANISMS

The XL2865A features several integrated mechanisms to protect it from inadvertent writes that might occur during system power supply transitions or periods of system noise. In addition to the user-controlled protection mechanisms, the following specialized circuits are built in.

OE Write Inhibit

If \overline{OE} is brought LOW before the \overline{CE} and \overline{WE} write command sequence, the internal nonvolatile write cycle will not occur. See the Mode Selection Table on page 3.

Noise Protection

Write pulses of less than 20ns duration on the WE pin will not initiate nonvolatile write cycles.



ABSOLUTE MAXIMUM RATINGS

Temperature Under Bias	55°C to +125°C
Lead Soldering Temperature (less than 10 seconds)	300°C
Supply Voltage	0 to 6.5V
Voltage on Any Pin (except \overline{OE})*	1.0V to +6.5V
Voltage on OE Pin*	1.0V to +22.0V
ESD Řating	2000V
DC Output Current	

^{*}With respect to ground

NOTE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and the functional operation of the device at these or any other conditions indicated in the operational sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Although this product includes specific circuitry to protect it from electrostatic discharge, conventional precautions should be taken to protect it from any voltages higher than the rated maxima.

DC CHARACTERISTICS

 $T_A = 0$ °C to +70°C for the XLS2865A or -40°C to +85°C for the XLE2865A, $V_{CC} = 5V \pm 5$ %

Symbol	Parameter	Test Conditions	Min.	Max.	Units
1 _{CC}	V _{CC} Current-Active	CE = OE = V _{IL} I/O's = open Other Inputs = 5.25V		110	mA
I _{SB}	V _{CC} Current-Standby	CE = V _{IH} OE = V _{IL} I/O's = open Other Inputs = 5.25V		50	mA
L	Input Leakage Current	V _{IN} = 0 to 5.25V	-10	10	μA
I _{LO}	Output Leakage Current	V _{OUT} = 0 to 5.25V	-10	10	μA
V _{IL}	Input Low Voltage		-0.5	0.8	V
V _{IH}	Input High Voltage		2.0	V _{CC} + 0.5	٧
V _{OL}	Output Low Voltage	I _{OL} = 2.1 mA		0.4	V
V _{OH}	Output High Voltage	I _{OH} = -400 μA	2.4		٧
V _H	High Voltage for Chip Erase		15	18	٧

CAPACITANCE

 T_{A} = +25°C, f = 1.0 MHz

Symbol	Test	Test Conditions	Max.	Units
C _{1/O}	Input/Output Capacitance	V _{I/O} = 0V	10	pF
C _{IN}	Input Capacitance	V _{IN} = 0V	6	pF



AC OPERATING CHARACTERISTICS

READ CYCLE (See Figure 2)

 $T_A = 0$ °C to +70°C for the XLS2865A or -40°C to +85°C for the XLE2865A, $V_{CC} = 5V \pm 5\%$

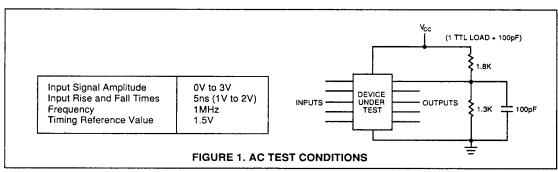
			XL2865A-250 Limits		XL2865A-300 Limits		XL2865A-350 Limits		XL2865A-450 Limits	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Units
t _{RC}	Read Cycle Time	250		300		350		450		ns
taa	Address Access Time	Ι.	250		300		350		450	ns
tce	Chip Enable Access Time		250		300		350		450	ns
toE	Output Enable Access Time		80		80		120		150	ns
t _{LZ}	Chip Enable to Output in Low Z	10		10		10		10		ns
t _{HZ}	Chip Disable to Output in High Z	10	80	10	80	10	100	10	100	ns
toLZ	Output Enable to Output in Low Z	10		10		10		10		ns
tonz .	Output Disable to Output in High Z	10	80	10	80	10	100	10	100	ns
tон	Output Hold from Address Change	20		20		20		20		ns

WRITE CYCLE (See Figures 3 and 4)

 $T_A = 0$ °C to +70°C for the XLS2865A or -40°C to +85°C for the XLE2865A, $V_{CC} = 5V \pm 5\%$

Symbol	Parameter	Min.	Max.	Units
twc	Nonvolatile Write Cycle Time		10	ms
tas	Address Setup Time	10		ns
tah	Address Hold Time	125		ns
tcs	Chip Enable or Write Enable Setup Time	0		ns
t _{CH}	Chip Enable or Write Enable Hold Time	0		ns
tcw	Chip Enable Pulse Width	150		ns
toes	Output Enable Setup Time	10		ns
t _{OEH}	Output Enable Hold Time	10		ns
t _{WP} *	Write Enable Pulse Width	50		ns
twpH	Write Recovery Time	50	j	ns
tov	Data Valid Time	50		ns
t _{DS}	Data Setup Time	50		ns
t _{DH}	Data Hold Time	10		ns
tpL	Page Load Time	300	600	μs
t _{BP}	CE and WE Low to R/B Low		150	ns
t _{BWR}	Busy to Write Recovery Time		25	μs
tBLC	Byte Load Cycle	0.2		μs

^{*} NOTE: A write pulse of less than 20ns will not initiate a write cycle.



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